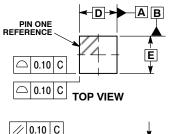
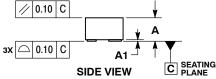


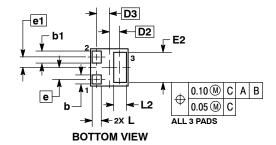


XLLGA3, 0.62x0.62 CASE 713AE **ISSUE O** 

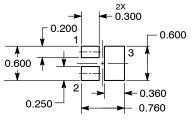
**DATE 05 MAR 2015** 







## RECOMMENDED SOLDER FOOTPRINT\*



**DIMENSIONS: MILLIMETERS** 

## NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.340	0.440	
A1	0.000	0.030	
b	0.100	0.200	
b1	0.150	0.250	
D	0.620 BSC		
D2	0.175 BSC		
D3	0.205 BSC		
Е	0.620 BSC		
E2	0.400	0.600	
е	0.200 BSC		
e1	0.175 BSC		
L	0.090	0.210	
L2	0.110	0.310	

## **GENERIC MARKING DIAGRAM\***



Х = Specific Device Code

= Date Code

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DESCRIPTION:	XLLGA3, 0.62X0.62		PAGE 1 OF 1

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<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

<sup>\*</sup>This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.